

To our customers,

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## Old Company Name in Catalogs and Other Documents

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April 1<sup>st</sup>, 2010  
Renesas Electronics Corporation

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## H7N0203AB

Silicon N Channel MOS FET  
High Speed Power Switching

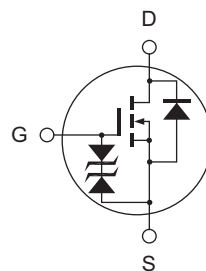
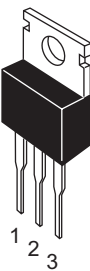
REJ03G1119-0500  
(Previous: ADE-208-1490C)  
Rev.5.00  
Sep 07, 2005

### Features

- Low on-resistance  
 $R_{DS(on)} = 2.4 \text{ m}\Omega$  typ.
- Low drive current
- 4.5 V gate drive device can be driven from 5 V source

### Outline

RENESAS Package code: PRSS0004AC-A  
(Package name: TO-220AB)



1. Gate
2. Drain (Flange)
3. Source

## Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Value	Unit
Drain to source voltage	V <sub>DSS</sub>	20	V
Gate to source voltage	V <sub>GSS</sub>	±20	V
Drain current	I <sub>D</sub>	90	A
Drain peak current	I <sub>D (pulse)</sub> <sup>Note 1</sup>	360	A
Body-drain diode reverse drain current	I <sub>DR</sub>	90	A
Avalanche current	I <sub>AP</sub> <sup>Note 2</sup>	20	A
Avalanche energy	E <sub>AR</sub> <sup>Note 2</sup>	40	mJ
Channel dissipation	P <sub>ch</sub> <sup>Note 3</sup>	100	W
Channel to case thermal impedance	θ <sub>ch-c</sub>	1.25	°C/W
Channel temperature	T <sub>ch</sub>	150	°C
Storage temperature	T <sub>stg</sub>	-55 to +150	°C

- Notes: 1. PW ≤ 10 μs, duty cycle ≤ 1%  
 2. Value at T<sub>ch</sub> = 25°C, R<sub>g</sub> ≥ 50 Ω  
 3. Value at T<sub>c</sub> = 25°C

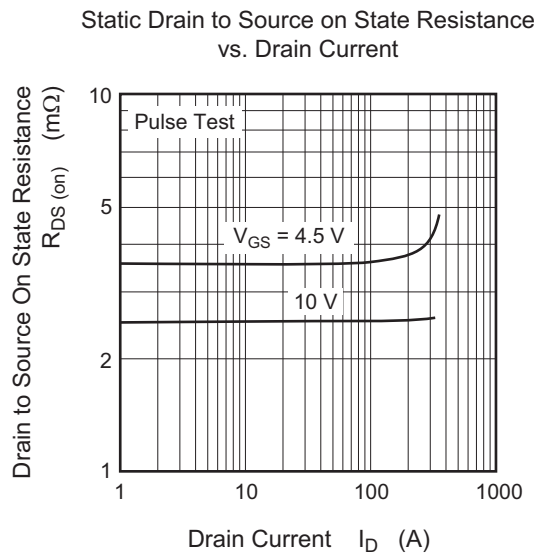
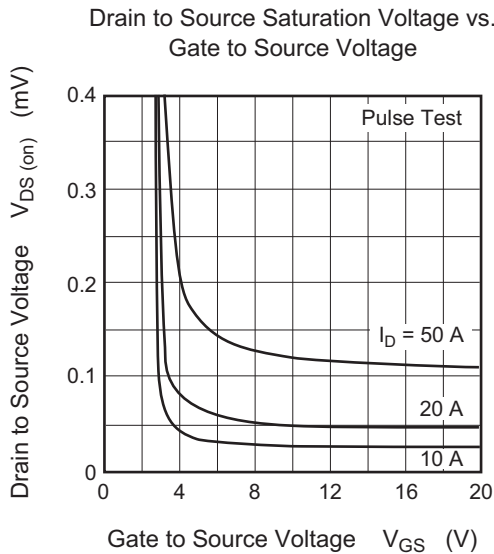
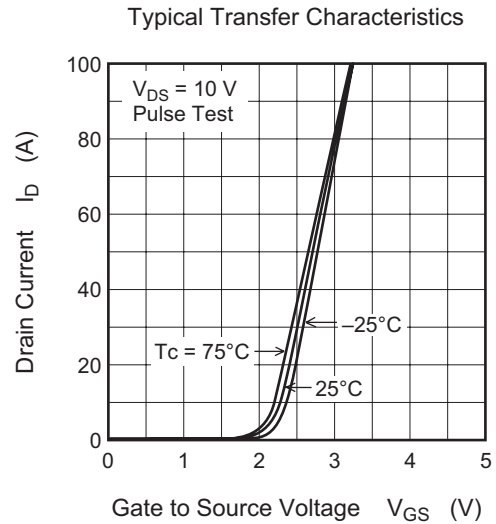
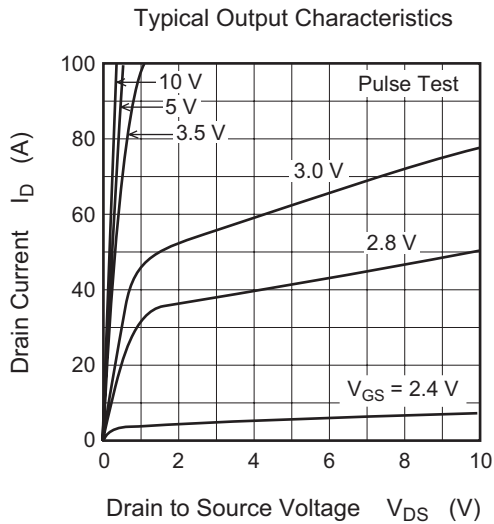
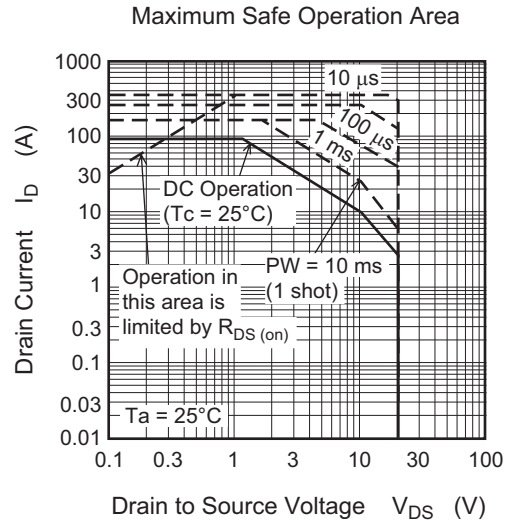
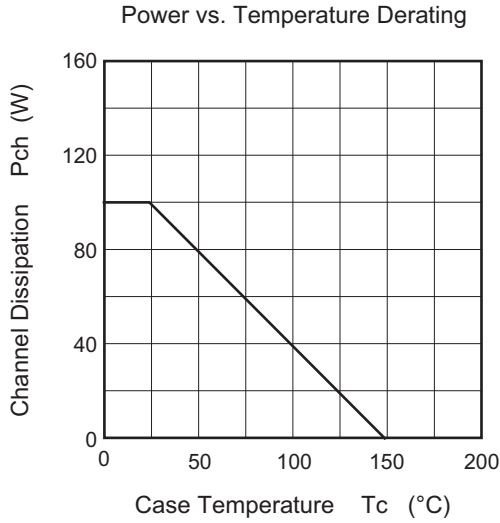
## Electrical Characteristics

(Ta = 25°C)

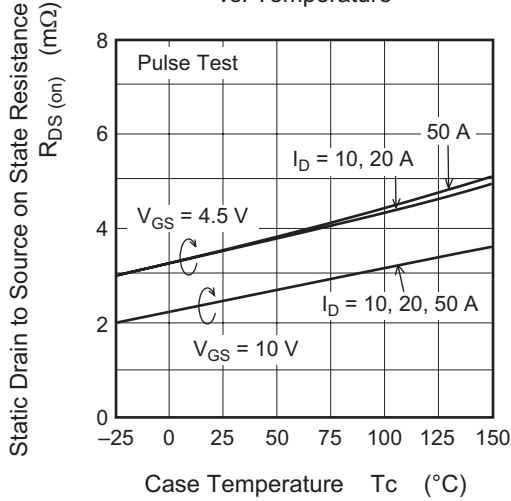
Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	V <sub>(BR)DSS</sub>	20	—	—	V	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0
Gate to source breakdown voltage	V <sub>(BR)GSS</sub>	±20	—	—	V	I <sub>G</sub> = ±100 μA, V <sub>DS</sub> = 0
Gate to source leak current	I <sub>GSS</sub>	—	—	±10	μA	V <sub>GS</sub> = ±16 V, V <sub>DS</sub> = 0
Zero gate voltage drain current	I <sub>DSS</sub>	—	—	10	μA	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0
Gate to source cutoff voltage	V <sub>GS (off)</sub>	1.0	—	2.5	V	I <sub>D</sub> = 1 mA, V <sub>DS</sub> = 10 V <sup>Note 4</sup>
Static drain to source on state resistance	R <sub>DS (on)</sub>	—	2.4	3.0	mΩ	I <sub>D</sub> = 45 A, V <sub>GS</sub> = 10 V <sup>Note 4</sup>
		—	3.5	5.1	mΩ	I <sub>D</sub> = 45 A, V <sub>GS</sub> = 4.5 V <sup>Note 4</sup>
Forward transfer admittance	y <sub>fs</sub>	80	140	—	S	I <sub>D</sub> = 45 A, V <sub>DS</sub> = 10 V <sup>Note 4</sup>
Input capacitance	C <sub>iss</sub>	—	6800	—	pF	V <sub>DS</sub> = 10 V
Output capacitance	C <sub>oss</sub>	—	1850	—	pF	V <sub>GS</sub> = 0
Reverse transfer capacitance	C <sub>rss</sub>	—	750	—	pF	f = 1 MHz
Total gate charge	Q <sub>g</sub>	—	110	—	nC	V <sub>DD</sub> = 10 V
Gate to source charge	Q <sub>gs</sub>	—	22	—	nC	V <sub>GS</sub> = 10 V
Gate to drain charge	Q <sub>gd</sub>	—	20	—	nC	I <sub>D</sub> = 90 A
Turn-on delay time	t <sub>d (on)</sub>	—	32	—	ns	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 45 A
Rise time	t <sub>r</sub>	—	380	—	ns	R <sub>L</sub> = 0.22 Ω
Turn-off delay time	t <sub>d (off)</sub>	—	110	—	ns	R <sub>g</sub> = 4.7 Ω
Fall time	t <sub>f</sub>	—	35	—	ns	
Body-drain diode forward voltage	V <sub>DF</sub>	—	0.90	—	V	I <sub>F</sub> = 90 A, V <sub>GS</sub> = 0
Body-drain diode reverse recovery time	t <sub>rr</sub>	—	60	—	ns	I <sub>F</sub> = 90 A, V <sub>GS</sub> = 0 di <sub>F</sub> /dt = 50 A/μs

Note: 4. Pulse test

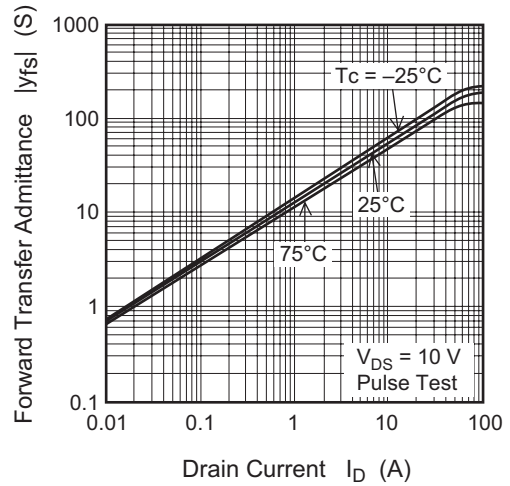
Main Characteristics



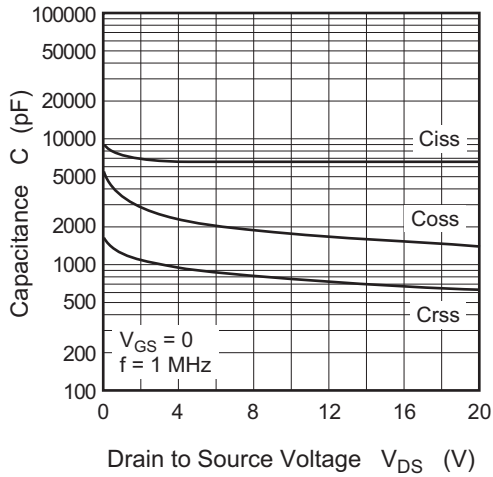
Static Drain to Source on State Resistance vs. Temperature



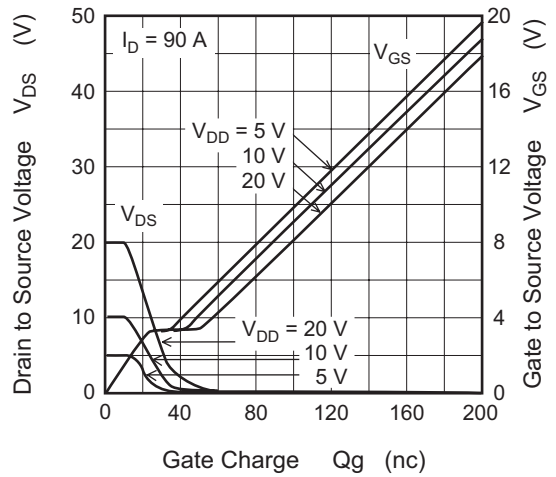
Forward Transfer Admittance vs. Drain Current



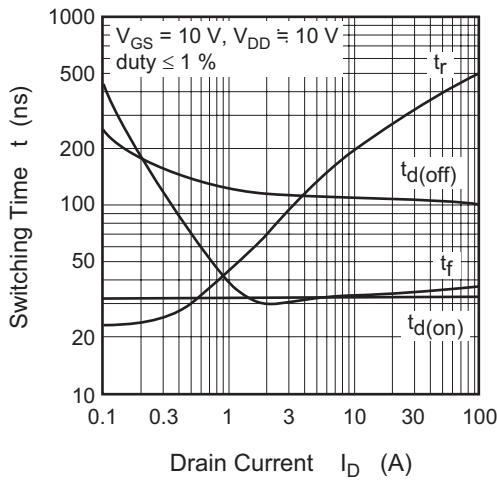
Typical Capacitance vs. Drain to Source Voltage



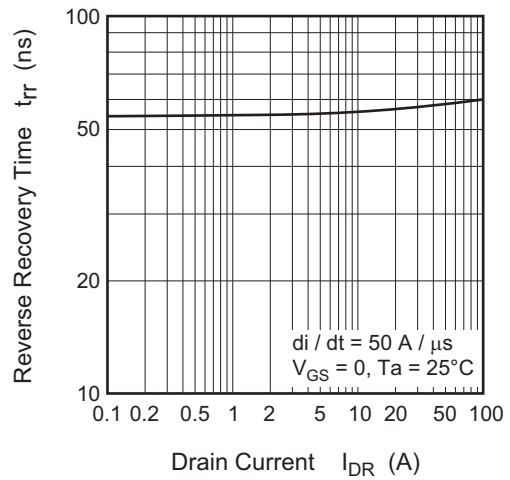
Dynamic Input Characteristics

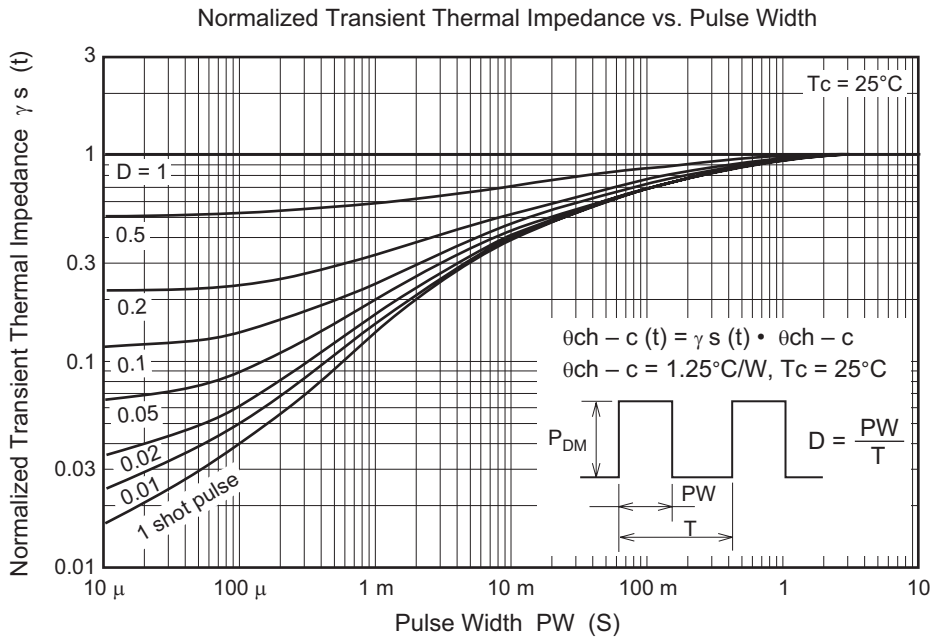
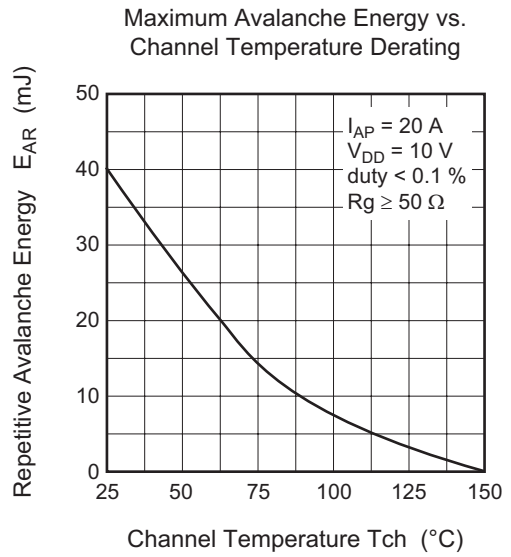
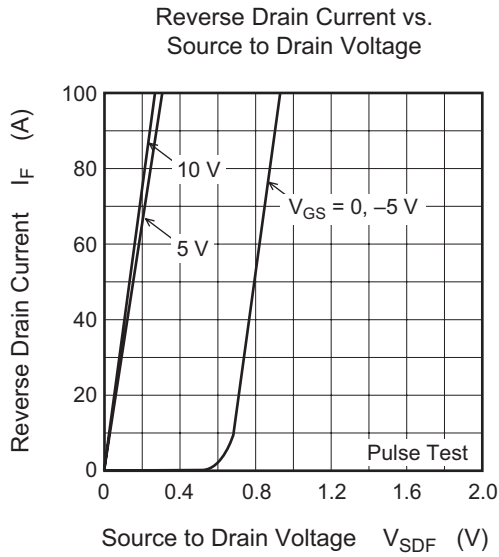


Switching Characteristics

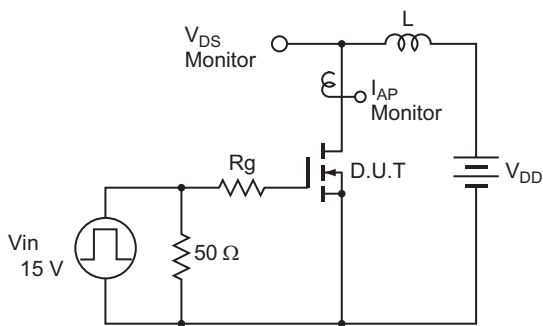


Static Drain to Source on State Resistance vs. Drain Current



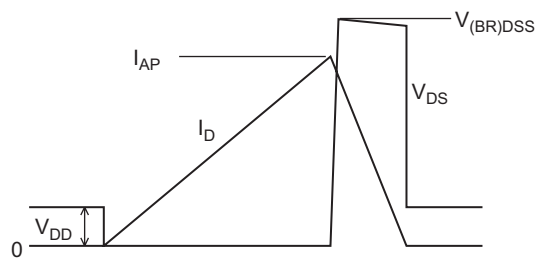


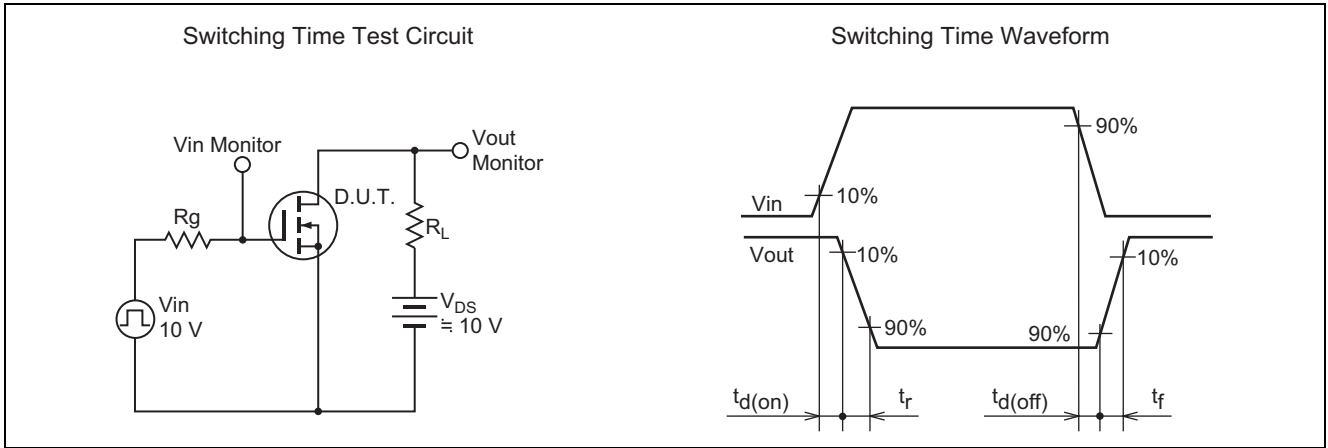
Avalanche Test Circuit



Avalanche Waveform

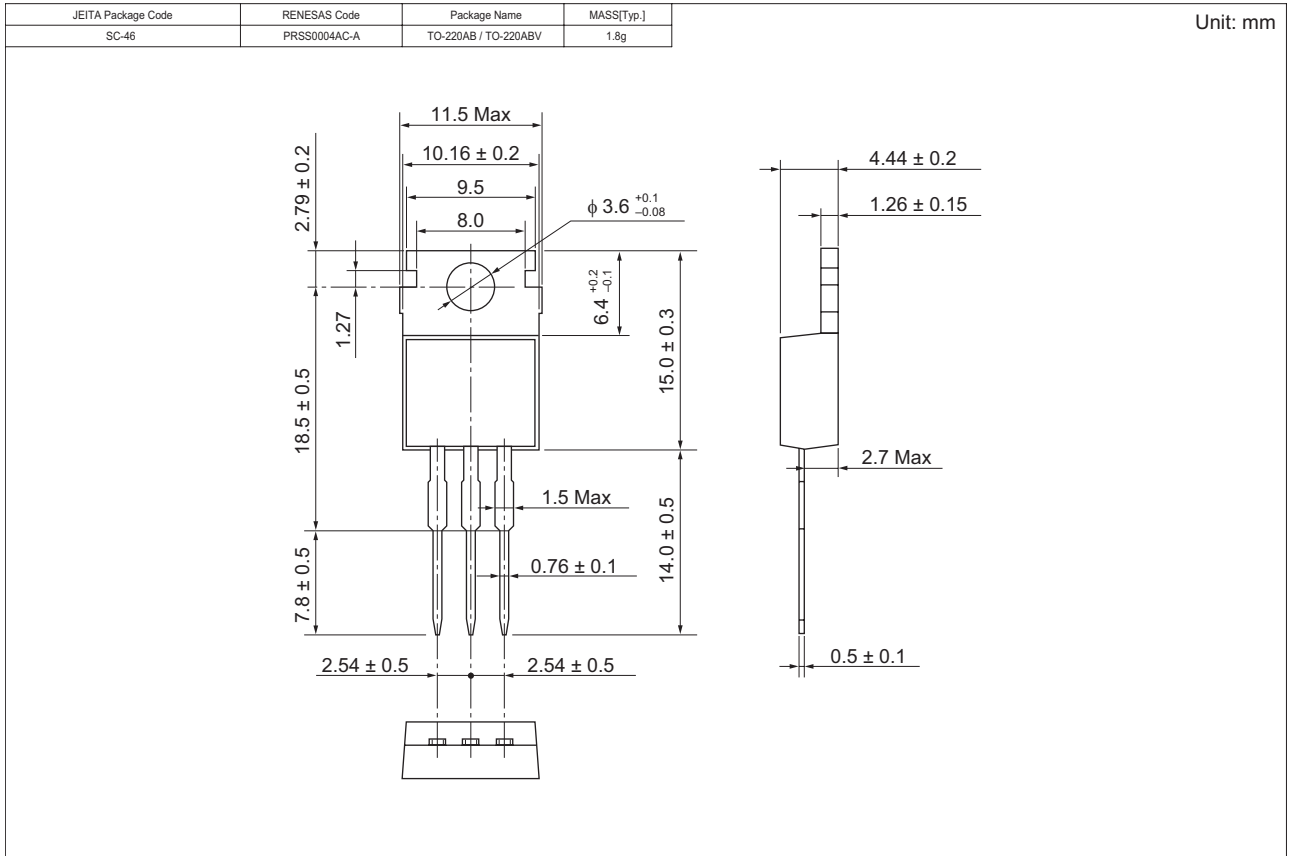
$$E_{AR} = \frac{1}{2} \cdot L \cdot I_{AP}^2 \cdot \frac{V_{DSS}}{V_{DSS} - V_{DD}}$$







### Package Dimensions



### Ordering Information

Part Name	Quantity	Shipping Container
H7N0203AB-E	500 pcs	Box (Sack)

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#### **Renesas Technology Malaysia Sdn. Bhd.**

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